

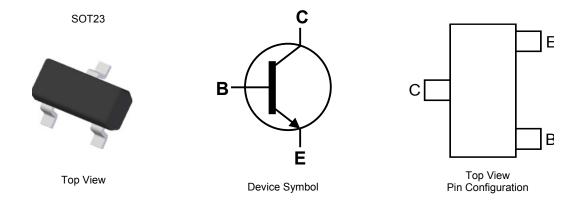
NPN SMALL SIGNAL TRANSISTOR IN SOT23

Features

- Epitaxial Planar Die Construction
- Ideal for Low Power Amplification and Switching
- Complementary PNP Type: MMBTA55 & MMBTA56
- Totally Lead-Free & Fully RoHS compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability
- PPAP capable (Note 4)

Mechanical Data

- Case: SOT23
- Case Material: Molded Plastic, "Green" Molding Compound UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin Plated Leads, Solderable per MIL-STD-202, Method 208 @3
- Weight: 0.008 grams (approximate)



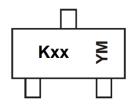
Ordering Information (Notes 4 & 5)

| Product | Compliance | Marking | Reel size (inches) | Tape width (mm) | Quantity per reel |
|---------------|------------|-----------|--------------------|-----------------|-------------------|
| MMBTA05-7-F | AEC-Q101 | K1G / K1H | 7 | 8 | 3,000 |
| MMBTA05Q-13-F | Automotive | K1G / K1H | 13 | 8 | 10,000 |
| MMBTA06-7-F | AEC-Q101 | K1G | 7 | 8 | 3,000 |
| MMBTA06Q-7-F | Automotive | K1G | 7 | 8 | 3,000 |

Notes:

- $1.\ No\ purposely\ added\ lead.\ Fully\ EU\ Directive\ 2002/95/EC\ (RoHS)\ \&\ 2011/65/EU\ (RoHS\ 2)\ compliant.$
- See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen and Antimony free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. Automotive products are AEC-Q101 qualified and are PPAP capable. Automotive, AEC-Q101 and standard products are electrically and thermally the same, except where specified. For more information, please refer to http://www.diodes.com/quality/product_compliance_definitions/.
- 5. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information



Kxx = Product Type Marking Code (See Ordering Information)

YM = Date Code Marking

Y or \overline{Y} = Year (ex: A = 2013)

M or \overline{M} = Month (ex: 9 = September)

Date Code Key

| Year | 2010 | 20 | 011 | 2012 | 2 | 013 | 2014 | | 2015 | 2016 | | 2017 |
|-------|------|-----|-----|------|-----|-----|------|-----|------|------|-----|------|
| Code | Χ | | Υ | Z | | Α | В | | С | D | | Е |
| Month | Jan | Feb | Mar | Apr | May | Jun | Jul | Aug | Sep | Oct | Nov | Dec |
| Code | 1 | 2 | 3 | 4 | 5 | 6 | 7 | 8 | 9 | 0 | N | D |



Absolute Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

| Characteristic | Symbol | MMBTA05 | MMBTA06 | Unit |
|---------------------------|------------------|---------|---------|------|
| Collector-Base Voltage | V _{CBO} | 60 | 80 | V |
| Collector-Emitter Voltage | V _{CEO} | 60 | 80 | V |
| Emitter-Base Voltage | V _{EBO} | 4 | .0 | V |
| Collector Current | Ic | 500 | | mA |
| Peak Collector Current | I _{CM} | | 1 | A |

Thermal Characteristics (@T_A = +25°C, unless otherwise specified.)

| Characteristic | Symbol | Value | Unit | |
|--|-----------------|------------------|------|--------|
| Power Dissipation | (Note 6) | D | 310 | mW |
| Power Dissipation | (Note 7) | P_{D} | 350 | IIIVV |
| Thermal Desigtance, Junction to Ambient | (Note 6) | 0 | 403 | 00/14/ |
| Thermal Resistance, Junction to Ambient | (Note 7) | R _{0JA} | 357 | °C/W |
| Thermal Resistance, Junction to Leads (Note 8) | | $R_{	heta JL}$ | 350 | °C/W |
| Operating and Storage Temperature Range | $T_{J,}T_{STG}$ | -55 to +150 | °C | |

ESD Ratings (Note 9)

| Characteristic | Symbol | Value | Unit | JEDEC Class |
|--|---------|-------|------|-------------|
| Electrostatic Discharge - Human Body Model | ESD HBM | 4,000 | V | 3A |
| Electrostatic Discharge - Machine Model | ESD MM | 400 | V | С |

Notes:

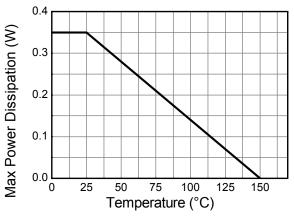
^{6.} For a device mounted on minimum recommended pad layout 1oz copper that is on a single-sided FR4 PCB; device is measured under still air conditions whilst operating in a steady-state.

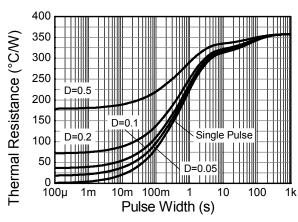
^{7.} Same as note (6), except the device is mounted on 15 mm x 15mm 1oz copper.

^{8.} Thermal resistance from junction to solder-point (at the end of the leads).
9. Refer to JEDEC specification JESD22-A114 and JESD22-A115.



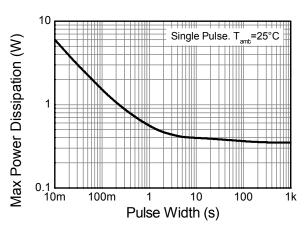
Thermal Characteristics and Derating Information





Derating Curve

Transient Thermal Impedance



Pulse Power Dissipation



Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

| Characteristic | | Symbol | Min | Max | Unit | Test Condition |
|---|--------------------|----------------------|----------|------|------|---|
| OFF CHARACTERISTICS | | | | | | |
| Collector-Base Breakdown Voltage | MMBTA05 MMBTA06 | BV _{CBO} | 60 80 | _ | V | I _C = 100μA, I _E = 0 |
| Collector-Emitter Breakdown Voltage (Note 10) | MMBTA05 MMBTA06 | BV _{CEO} | 60 80 | _ | V | I _C = 10.0mA, I _B = 0 |
| Emitter-Base Breakdown Voltage | | BV _{EBO} | 4.0 | _ | V | $I_E = 100 \mu A, I_C = 0$ |
| Collector Cutoff Current | MMBTA05 MMBTA06 | I _{CBO} | _ | 100 | nA | $V_{CB} = 60V, I_{E} = 0$ $V_{CB} = 80V, I_{E} = 0$ |
| Collector Cutoff Current | MMBTA05 MMBTA06 | I _{CES} | _ | 100 | nA | V _{CE} = 60V, I _{BO} = 0V V _{CE} = 80V, I _{BO} = 0V |
| ON CHARACTERISTICS (Note 10) | | | | | | |
| DC Current Gain | | h _{FE} | 100 | _ | _ | I _C = 10mA, V _{CE} = 1.0V I _C = 100mA, V _{CE} = 1.0V |
| Collector-Emitter Saturation Voltage | | V _{CE(sat)} | _ | 0.25 | V | I _C = 100mA, I _B = 10mA |
| Base-Emitter Saturation Voltage | | V _{BE(sat)} | | 1.2 | V | I _C = 100mA, V _{CE} = 1.0V |
| SMALL SIGNAL CHARACTERISTICS | | | | | | |
| Current Gain-Bandwidth Product | | f _T | 100 | _ | MHz | $V_{CE} = 2.0V, I_{C} = 10mA, f = 100MHz$ |

Note: 10. Measured under pulsed conditions. Pulse width \leq 300 μ s. Duty cycle \leq 2%.



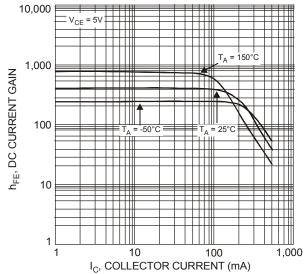


Figure 1 Typical DC Current Gain vs. Collector Current

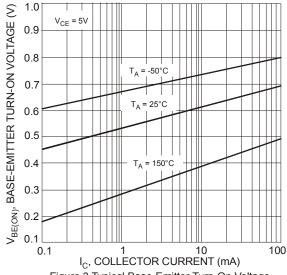


Figure 3 Typical Base-Emitter Turn-On Voltage vs. Collector Current

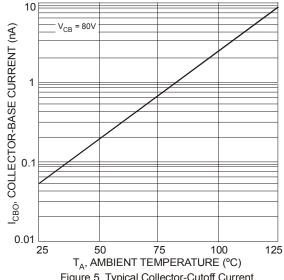


Figure 5 Typical Collector-Cutoff Current vs. Ambient Temperature

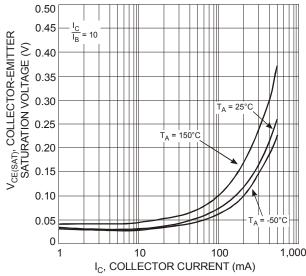


Figure 2 Collector-Emitter Saturation Voltage vs. Collector Current

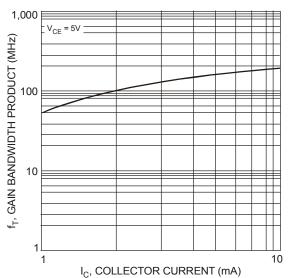


Figure 4 Typical Gain Bandwidth Product vs. Collector Current

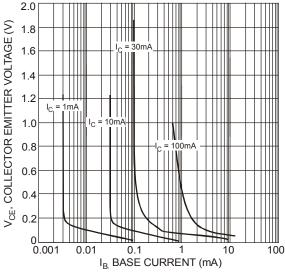
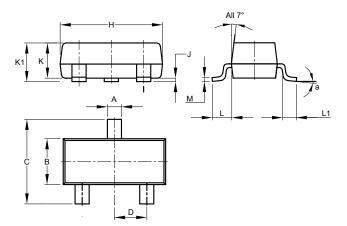


Figure 6 Typical Collector Saturation Region



Package Outline Dimensions

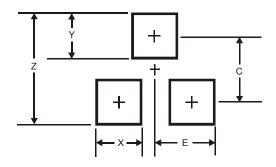
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for latest version.



| | SOT23 | | | | | | |
|-----|--------|---------|-------|--|--|--|--|
| Dim | Min | Max | Тур | | | | |
| Α | 0.37 | 0.51 | 0.40 | | | | |
| В | 1.20 | 1.40 | 1.30 | | | | |
| С | 2.30 | 2.50 | 2.40 | | | | |
| D | 0.89 | 1.03 | 0.915 | | | | |
| F | 0.45 | 0.60 | 0.535 | | | | |
| G | 1.78 | 2.05 | 1.83 | | | | |
| Н | 2.80 | 3.00 | 2.90 | | | | |
| J | 0.013 | 0.10 | 0.05 | | | | |
| K | 0.890 | 1.00 | 0.975 | | | | |
| K1 | 0.903 | 1.10 | 1.025 | | | | |
| L | 0.45 | 0.61 | 0.55 | | | | |
| L1 | 0.25 | 0.55 | 0.40 | | | | |
| M | 0.085 | 0.150 | 0.110 | | | | |
| а | 8° | | | | | | |
| All | Dimens | ions in | mm | | | | |

Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



| Dimensions | Value (in mm) |
|------------|---------------|
| Z | 2.9 |
| X | 0.8 |
| Y | 0.9 |
| С | 2.0 |
| E | 1.35 |



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